

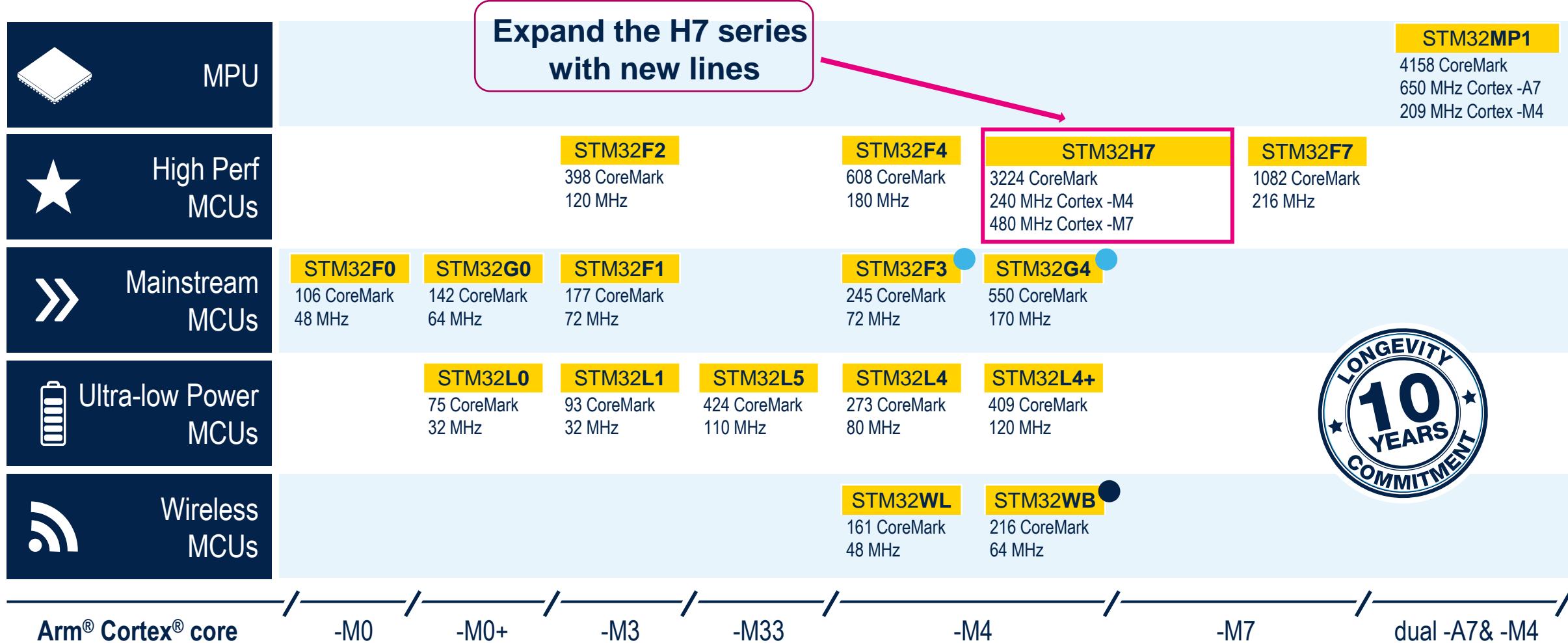
## **STM32H7 series**

### **New STM32H7 lines in development :**

**STM32H723/H733 line**  
**STM32H725/H735 line**  
**STM32H730(Q) Value Line**



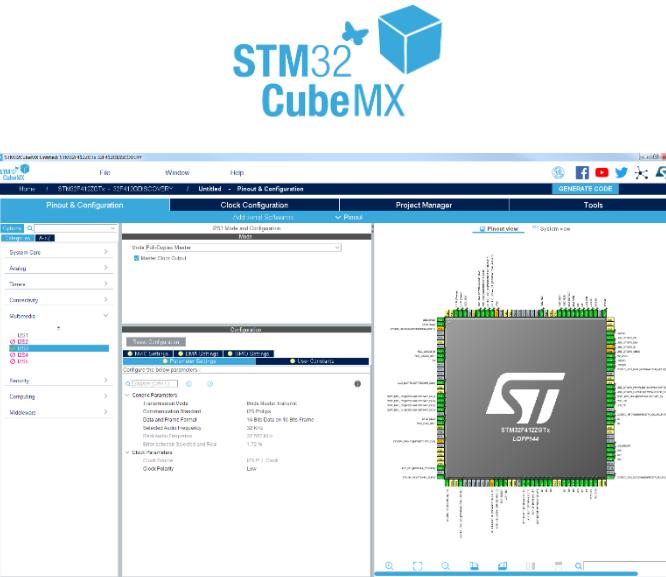
# STM32 MCU & MPU roadmap



# Software Development Tools

## C/C++ Focus

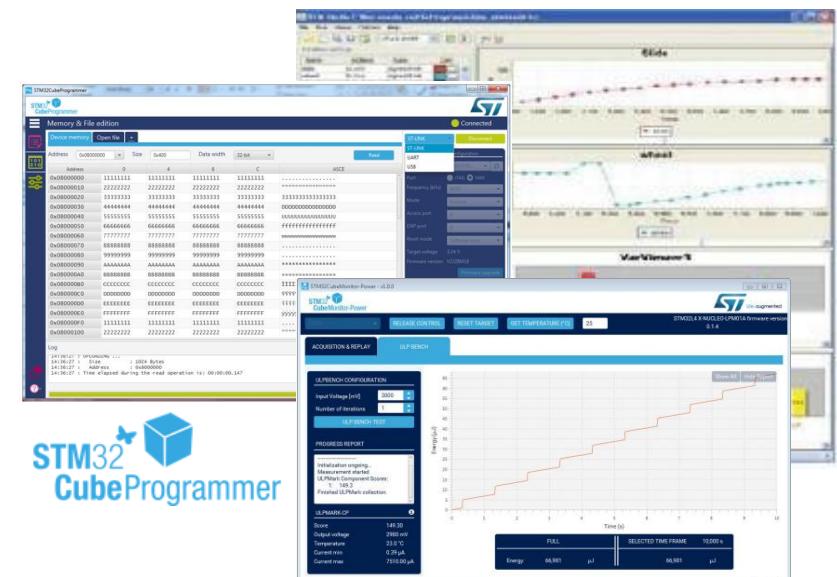
A complete flow, from configuration up to monitoring



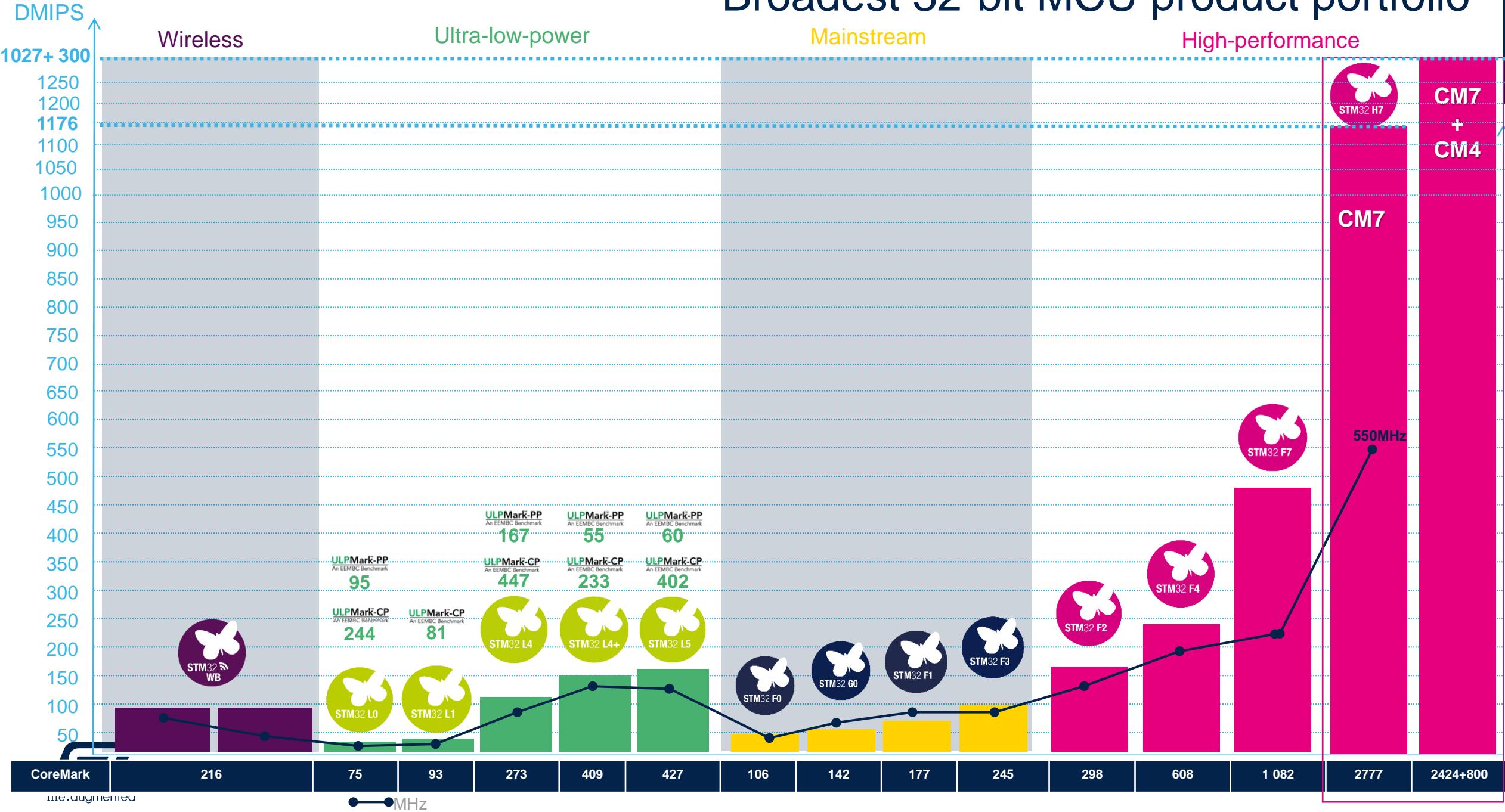
**STM32CubeMX**  
Configure & Generate Code

**IDEs**  
Compile and Debug

**STM32CubeProgrammer**  
**STM32CubeMonitor**  
Program & Monitor



# Broadest 32-bit MCU product portfolio



# STM32H723/733, STM32H725/735 and STM32H730 lines HIGHLIGHTS

- Expand the current STM32H7 series with a subset product, smaller and cost optimized. 3 lines are proposed.
- **STM32H723/733, STM32H725/735 and STM32H730** lines are leaning on the STM32H7 DNA . Maximum performance, high integration, advanced features, ECC on all embedded memories and High temperature up to 125C ambient support are maintained.
- A significant performance increase and some new features:
  - Max Frequency up to 550MHz
  - Octal-SPI support with On-The-Fly-Decrypt for increased perf vs Quad-SPI, more security (On-The-Fly-Decrypt) and Octal-RAM support
  - Math acceleration (Trigonometric and Filtering) to off-load the core
  - ITCM RAM re-map capability for more flexibility in the code partitioning
  - Fast 12-bit ADC (in addition to the 16-bit ADC) for more flexibility
  - Parallel synchronous slave interface (PSSI) for more connectivity
  - New VFQFPN68 introduced for a more aggressive entry price and integration
- **STM32H730 Value Line:**
  - Reduced Flash size down to 128KB mainly for user Bootloader storage and adjust to external memories environment
  - Secure services/Crypto/On-The-Fly-Decrypt by default on the STM32H730xxx and STM32H730xxxQ part numbers

# STM32H7 Target Applications

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- Industrial
  - Human Machine Interface
  - Communication Gateway
  - PLC
  - Motion control
  - Barcode Reader
  - Inverters, UPS
  - Sensors
  - Asset protections
  - Lighting
- Medical
  - Health and wellness
  - Individual assistance (hearing, respiratory)
  - Measurements and Data logger



- Consumer
  - Advanced IoT edge gateway
  - Access control
  - Home Gateway
  - Appliance
  - Graphic
  - Home Automation
  - Audio
  - Fitness Equipment
  - Drones
  - Portable devices and accessories

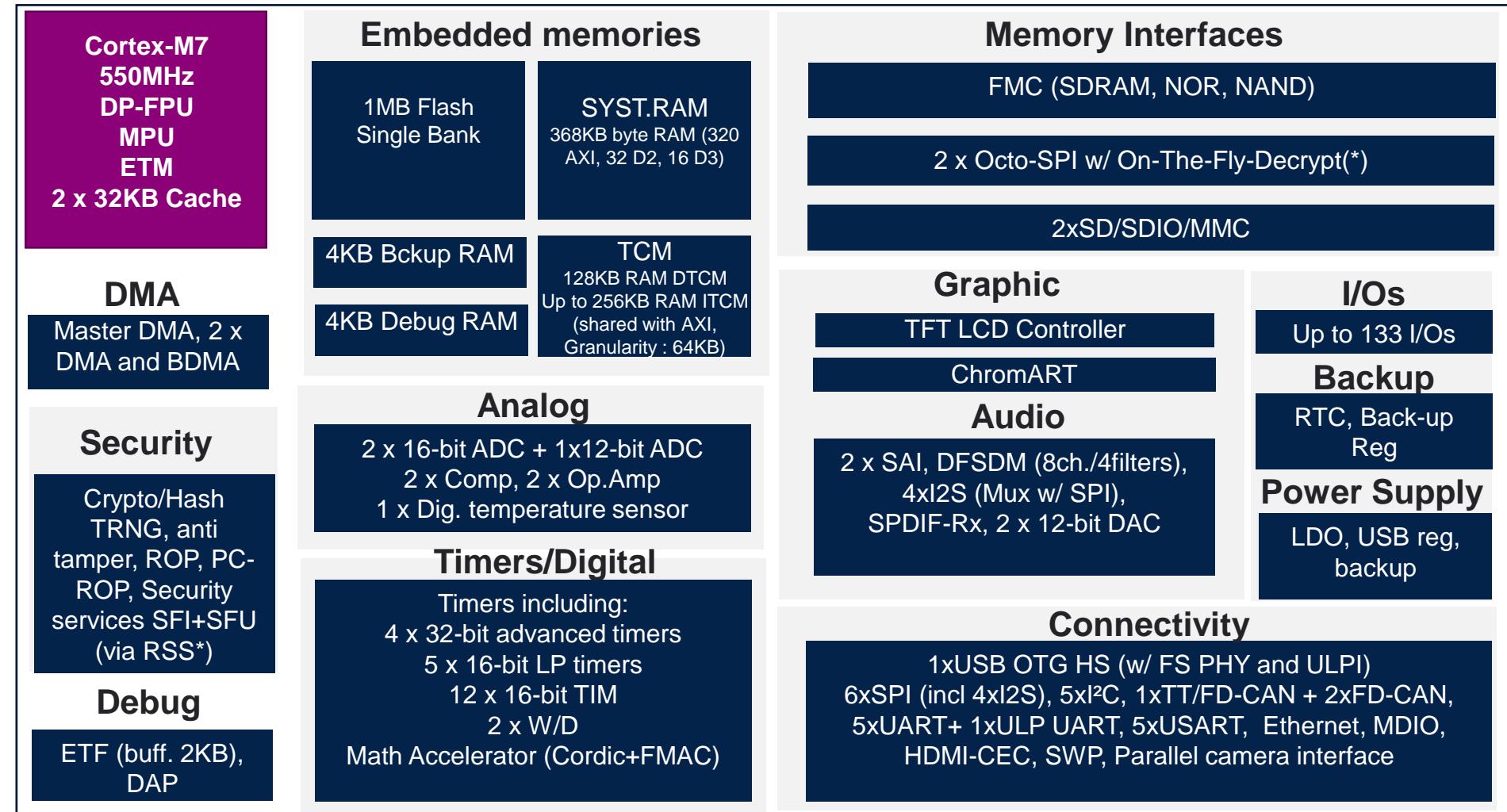
and more ...

# STM32H723/733 Line Block diagram

High integration, high performance, 3 x power domains, LDO,  
compatible with the STM32H753/H743 on common packages

## Key features

- ✓ *Performance*
  - ✓ *RAM re-map*
  - ✓ *ECC on all memories*
  - ✓ *Multiple high perf ADC*
  - ✓ *Graphic*
  - ✓ *Security*
  - ✓ *Math accel.*
  - ✓ *Memory interfaces*
  - ✓ *Connectivity*
  - ✓ *Power supply scheme*
  - ✓ *STM32 DNA*
- (Compatibility, packages, Ecosyst)



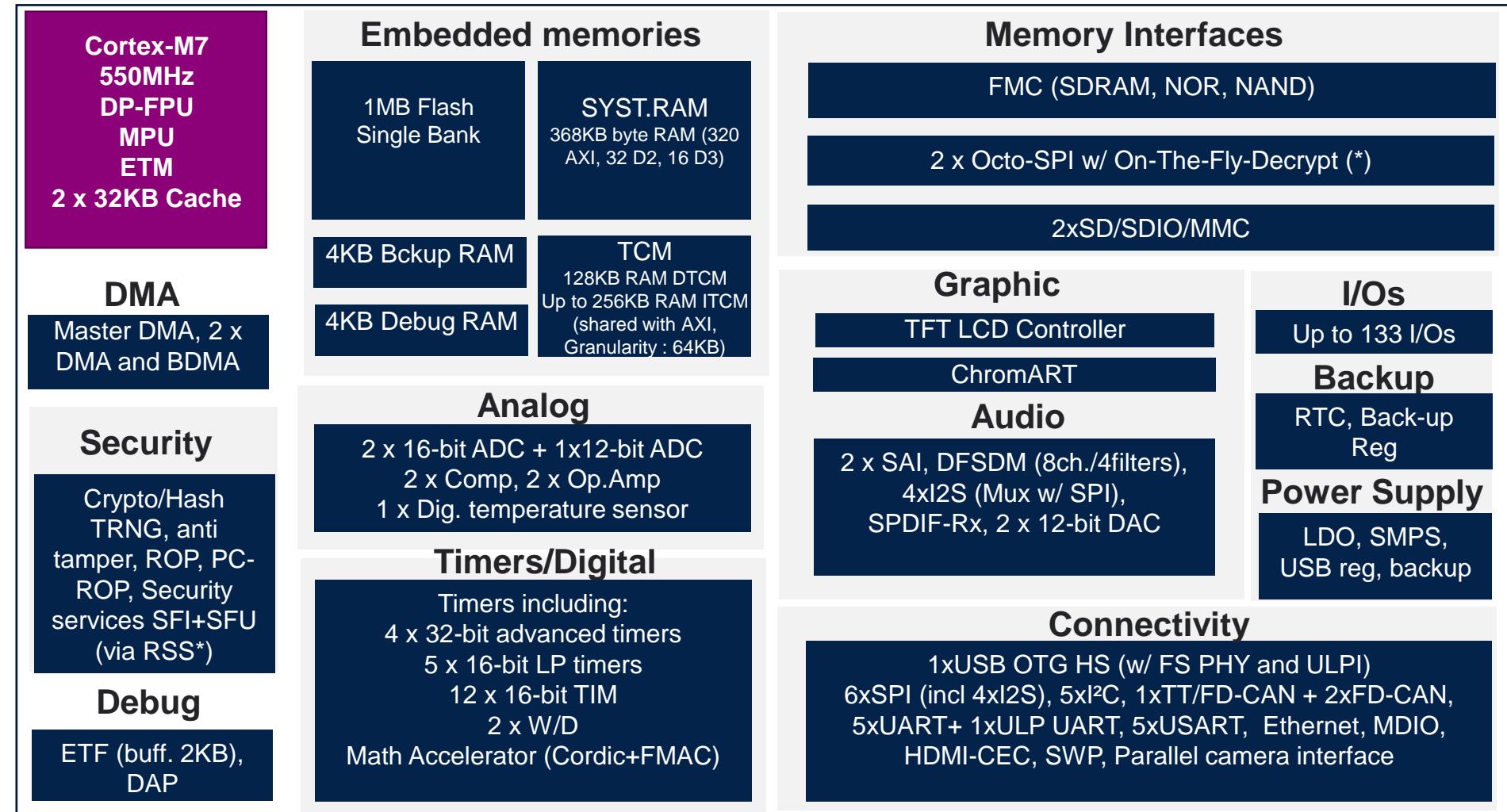
(\*) : on STM32H733 CPN (Crypto)

# STM32H725/735 line block diagram

High integration, high performance, 3 x power domains, SMPS and LDO,  
compatible with the STM32H745 and STM32H755 on common packages

## Key features

- ✓ *Performance*
- ✓ *RAM re-map*
- ✓ *ECC on all memories*
- ✓ *Multiple high perf ADC*
- ✓ *Graphic*
- ✓ *Security*
- ✓ *Math accel.*
- ✓ *Memory interfaces*
- ✓ *Connectivity*
- ✓ *Power supply scheme*  
(*SMPS or LDO. Except QFN68-SMPS only*)
- ✓ *STM32 DNA*  
(*Compatibility, packages, Ecosyst*)
- ✓ *Extended Temp range*  
*support 125C*  
(*dedicated CPN\*\**)

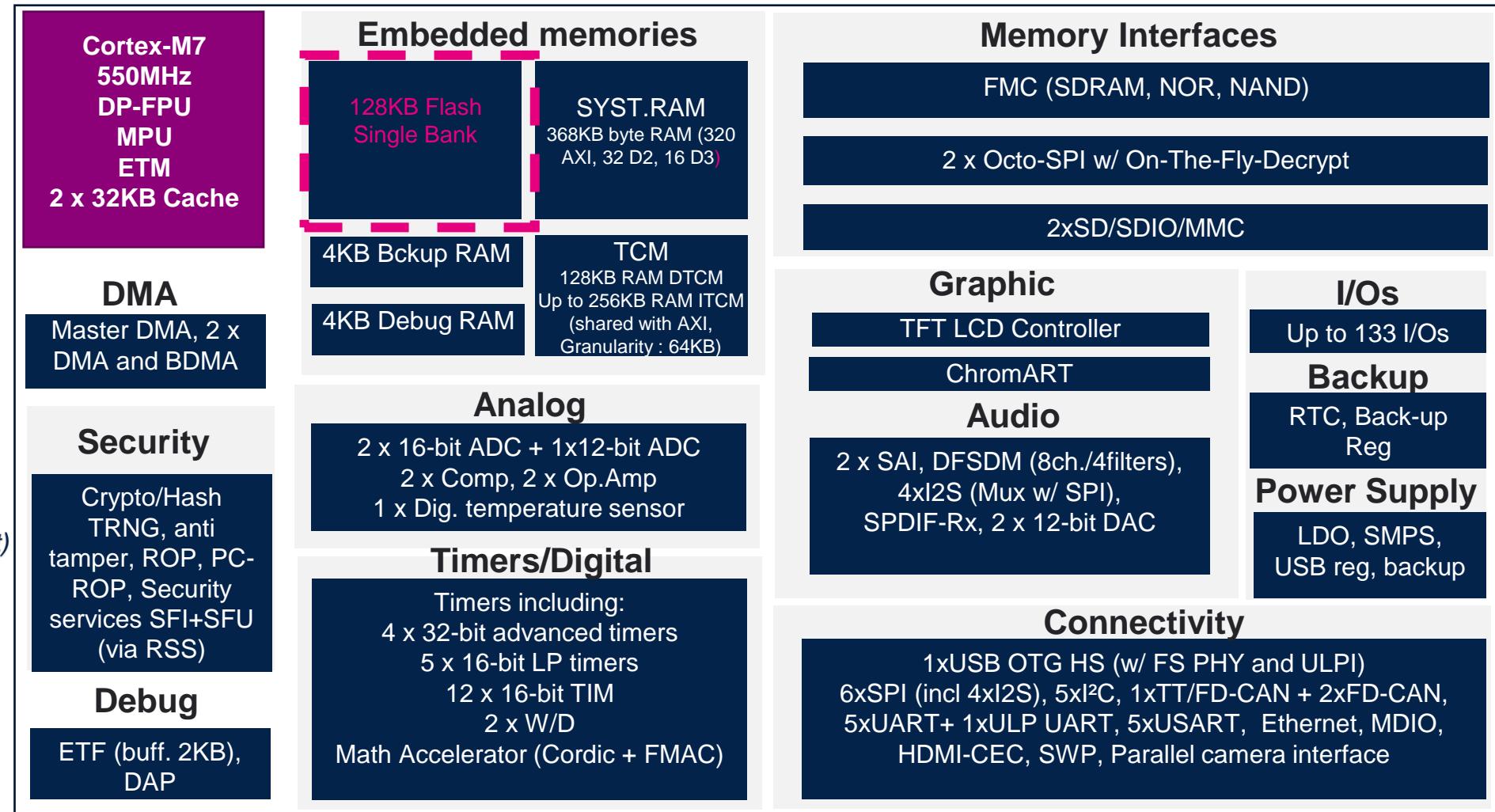


# STM32H730 and STM32H730Q – Value line

High performance, Flash kept to the essential 128KB, 3 x power domains, LDO (and SMPS on the -Q), compatible with the STM32H733 or STM32H735 on common packages, Security services

## Key features

- ✓ Performance
- ✓ RAM re-map
- ✓ **Flash 128KB**
- ✓ ECC on all memories
- ✓ Multiple high perf ADC
- ✓ Graphic
- ✓ Security
- ✓ Math accel.
- ✓ Memory interfaces
- ✓ Connectivity
- ✓ Power supply scheme (**SMPS on CPN with "Q"**)
- ✓ STM32 DNA  
(Compatibility, packages, Ecosyst)



# ITCM $\longleftrightarrow$ AXI RAM remap capability

Both the CM7 ITCM interface and the AXI SRAM one shares a subset system physical memory cuts. 4 configurations are supported.

## RAM shared between ITCM and AXI RAM

192 Kbyte of RAM can be used either as ITCM or as AXI SRAM. This feature can be configured through the TCM\_AXI\_SHARED[1:0] option byte in FLASH\_OPTSR2\_PRG register as described in [Table 7](#).

**Table 7. ITCM/DTCM/AXI configuration**

TCM_AXI_SHARED[1,0]	ITCM size (Kbyte)	ITCM memory mapping	AXI size (Kbyte)	AXI memory mapping
00	64	0x0000 0000 - 0x0000 FFFF	320	0x2400 0000 - 0x2404 FFFF
01	128	0x0000 0000 - 0x0001 FFFF	256	0x2400 0000 - 0x2403 FFFF
10	192	0x0000 0000 - 0x0002 FFFF	192	0x2400 0000 - 0x2402 FFFF
11	256	0x0000 0000 - 0x0003 FFFF	128	0x2400 0000 - 0x2401 FFFF

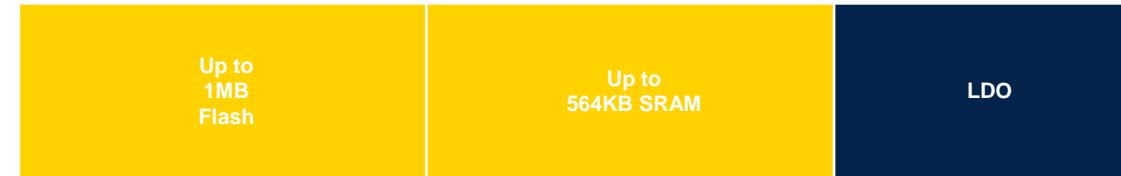
Extract from preliminary Reference Manual RM0468.

# STM32H723/725/730 Lines

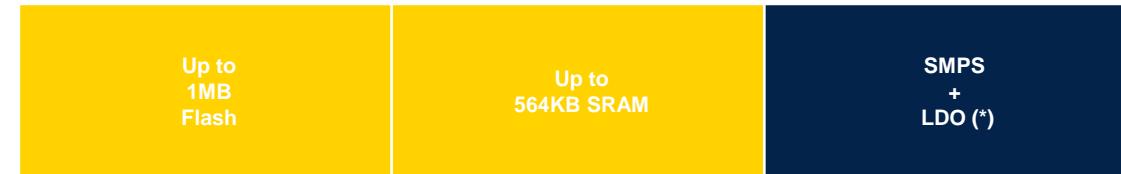
Common features
Cortex™-M7 550MHz+ with DP-FPU and 2x32KB Cache
External memory interfaces : (FMC, 2 x Octo SPI w/ On-The-Fly-Decrypt and 2 x SDMMC )
TFT-LCD controller and ChromART
Low-voltage 1.62V to 3.6V
Audio support with 2xSAI, 4xI2S, DFSDM 4filt/8ch, 2 x 12-bit DAC
USB OTG
Ethernet MAC
3 x CAN FD (incl. one with TT support)
6xSPI, 5xI <sup>2</sup> C, 5xUART+ 1xULP UART, 5xUSART
Multiple 16 and 32-bit timers Incl. Low power timers
Parallel camera interface
2 x 16-bit ADC 3.6MSPS 1 x 12-bit ADC 5MSPS
2 x PGA and 2 x Comp.
Built-in 64MHz, 48MHz, 4MHz and 40KHz RC oscillators
HSE + LSE clocks
RTC + Sub-RTC
2xWD, POR/PDR, BOR/PVD, voltage scaling



Line 1 : STM32H723 and STM32H733 (with crypto and security services\*\*)



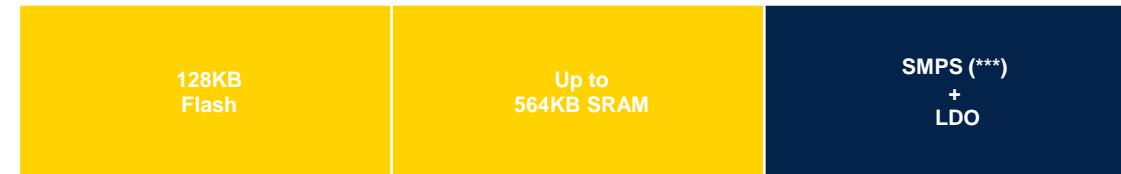
Line 2 : STM32H725 and STM32H735 (with crypto and security services\*\*)



(\*) : except QFN68 package (SMPS only)

(\*\*) : crypto CPN enable : Crypto/Hash accelerator, RSS for security services and On-The-Fly-Decrypt features

Line 3 : STM32H730/STM32H730Q (with crypto and security services on all Value Line CPN)



(\*\*\*) : SMPS available only on STM32H730Q CPN

# STM32H733/723/735/725/730 product lines summary

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Cortex®-M7	Core, Memories and acceleration • Single core Cortex-M7 550MHz • Flash and RAM acceleration • RAM re-map capability • DP-FPU • 4xDMA  Connectivity • 1 x USB2.0 OTG FS/HS • 2xSDMMC • USART, UART, SPI, I²C • 3xCAN (2xFD and 1xTT) • HDMI-CEC • FMC, Dual OctoSPI • Ethernet MAC IEEE1588 • Camera I/F • Analog (comp, AOP)	Product line	FCPU MHz	SB FLASH (bytes)	RAM (KB)	Power supply	T° range
Cortex®-M7	<b>STM32H725 and STM32H735 (*)</b>  <b>STM32H723 and STM32H733 (*)</b>  <b>STM32H730 STM32H730Q</b> <span style="color: red;">Value Line</span>	STM32H725 and STM32H735 (*)	550	Up to 1MB	564KB (incl.128K DTCM, 432KB Syst + 4K bckup)	SMPS(****) + LDO	Standard 85°C (125°C Optional)**
		STM32H723 and STM32H733 (*)	550	Up to 1MB	564KB (incl.128K DTCM, 432KB Syst + 4K bckup)	LDO	Standard 85°C
		STM32H730 STM32H730Q	550	128K	564KB (incl.128K DTCM, 432KB Syst + 4K bckup)	SMPS(***) + LDO	Standard 85°C

(\*) : Crypto and Security services on CPN : STM32H733, STM32H735 and STM32H730

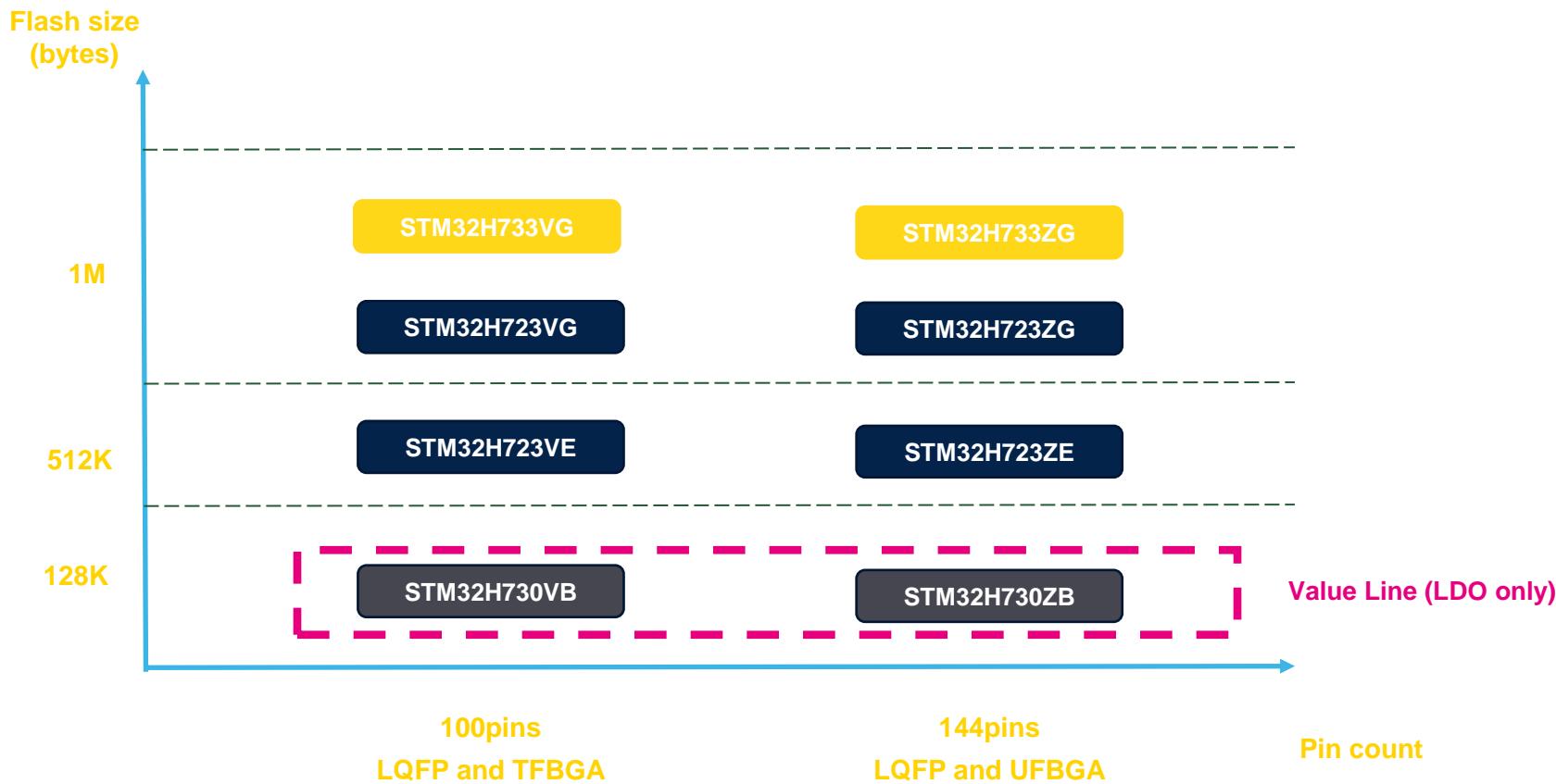
(\*\*) : Extended Temp range Max 125C Amb/140C junction. Dedicated part numbers in "3" extension instead of "6"

(\*\*\*) : SMPS available only on STM32H730Q CPN

(\*\*\*\*) : SMPS only on the QFN68 variant (no LDO)

# STM32H723/733 GP and STM32H730 Value Lines

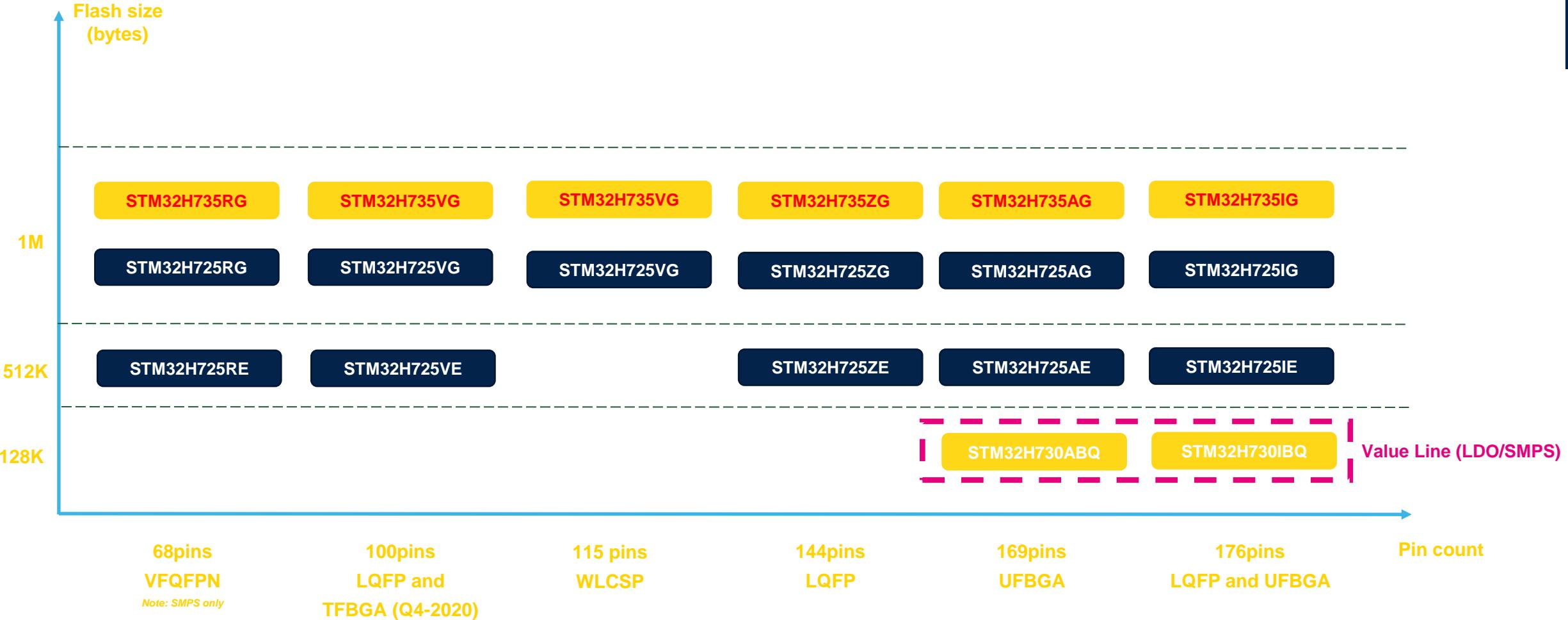
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## CPN list

STM32H733VGT6, STM32H733VGH6, STM32H733ZGT6, STM32H733ZGI6  
STM32H723VGT6, STM32H723VGH6, STM32H723ZGT6, STM32H723ZGI6  
STM32H723VET6, STM32H723VEH6, STM32H723ZET6, STM32H723ZEI6  
STM32H730VBT6, STM32H730VBH6, STM32H730ZBT6, STM32H730ZBI6

# STM32H725/735 Industrial and STM32H730Q value lines

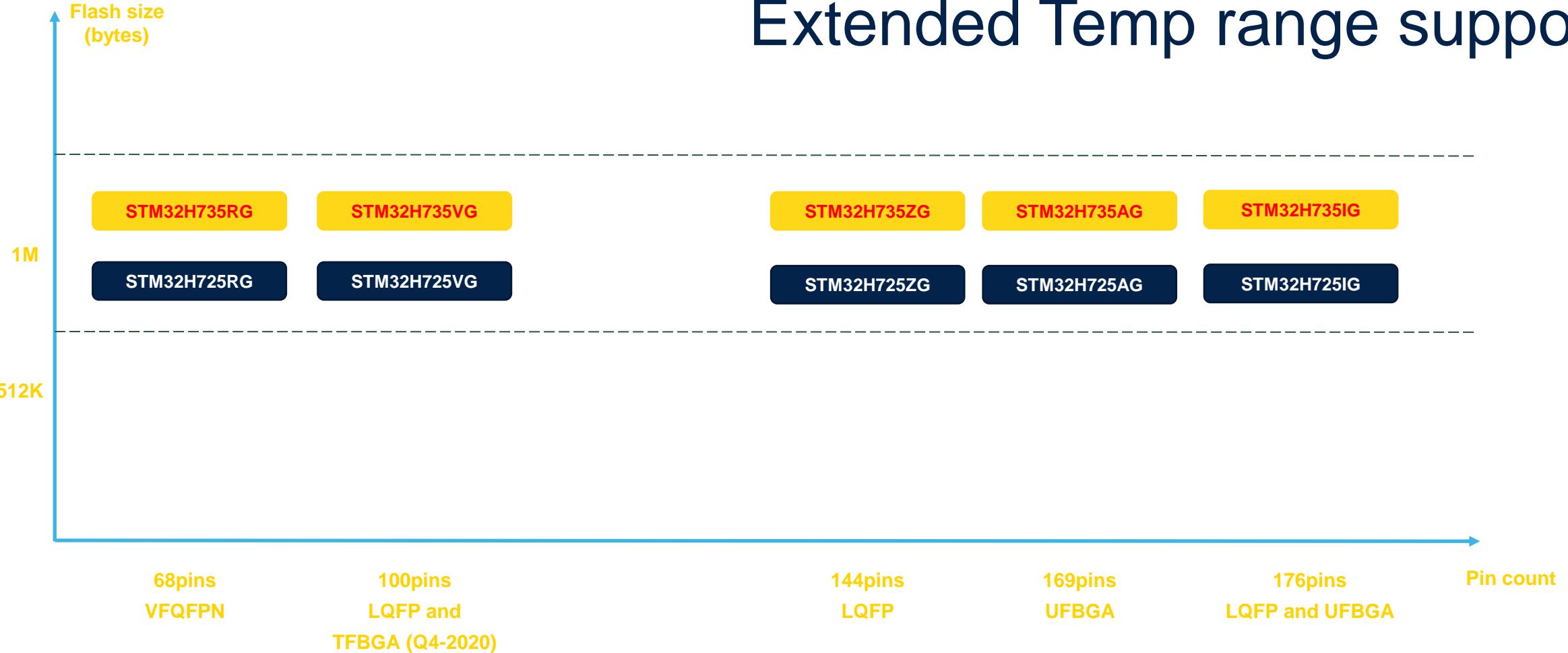


## CPN list

STM32H735RGV6, STM32H735VGT6, STM32H735VGH6, STM32H735VGY6TR, STM32H735ZGT6, STM32H735AGI6, STM32H735IGT6, STM32H735IGK6  
STM32H725RGV6, STM32H725VGT6, STM32H725VGH6, STM32H725VGY6TR, STM32H725ZGT6, STM32H725AGI6, STM32H725IGT6, STM32H725IGK6  
STM32H725REV6, STM32H725VET6, STM32H725VEH6, STM32H725ZET6, STM32H725AEI6, STM32H725IET6, STM32H725IEK6  
STM32H730ABI6Q, STM32H730IBT6Q, STM32H730IBK6Q

# STM32H725/735

## Extended Temp range support

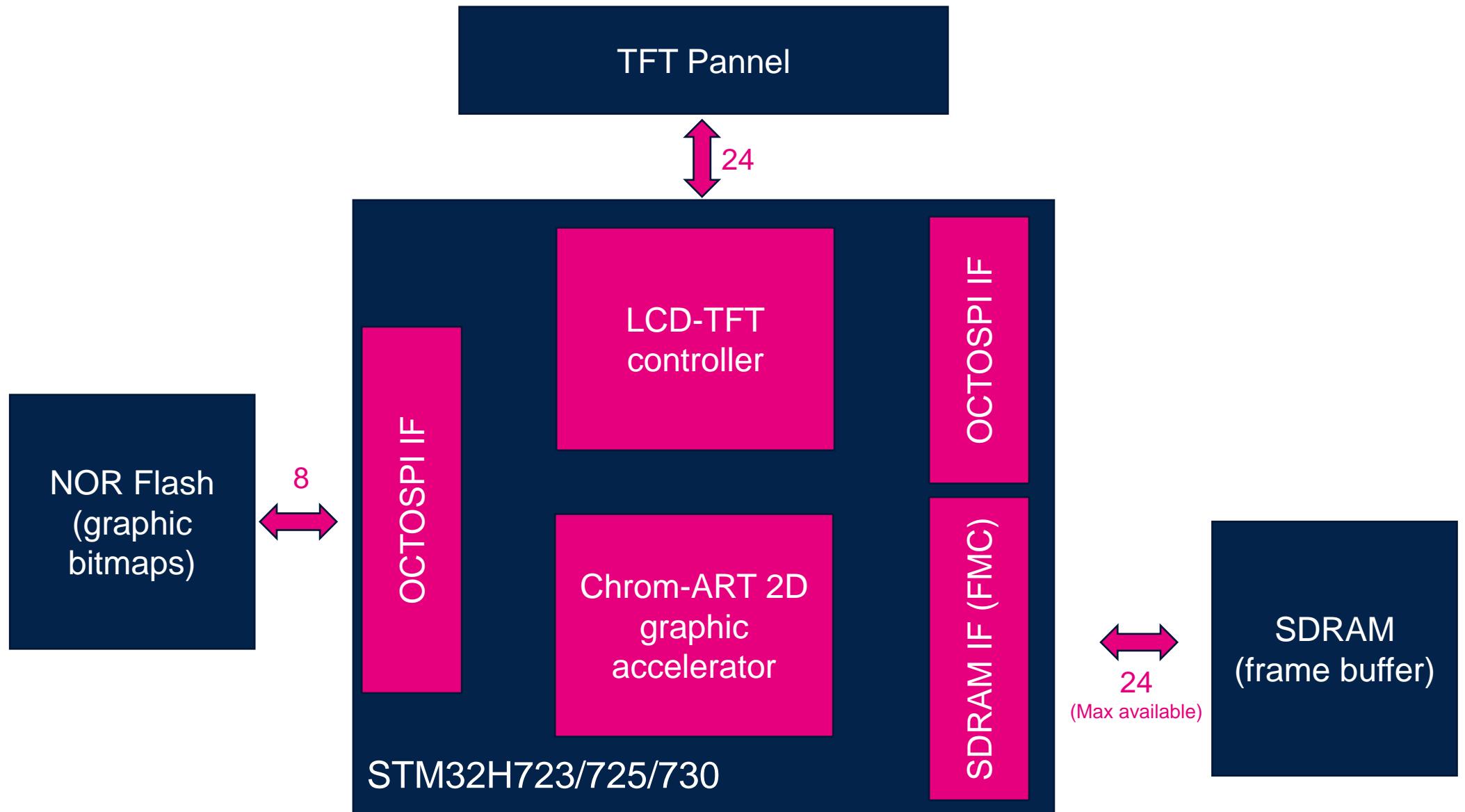


**CPN list in range « 3 » - Ta = [-40C +125C]**

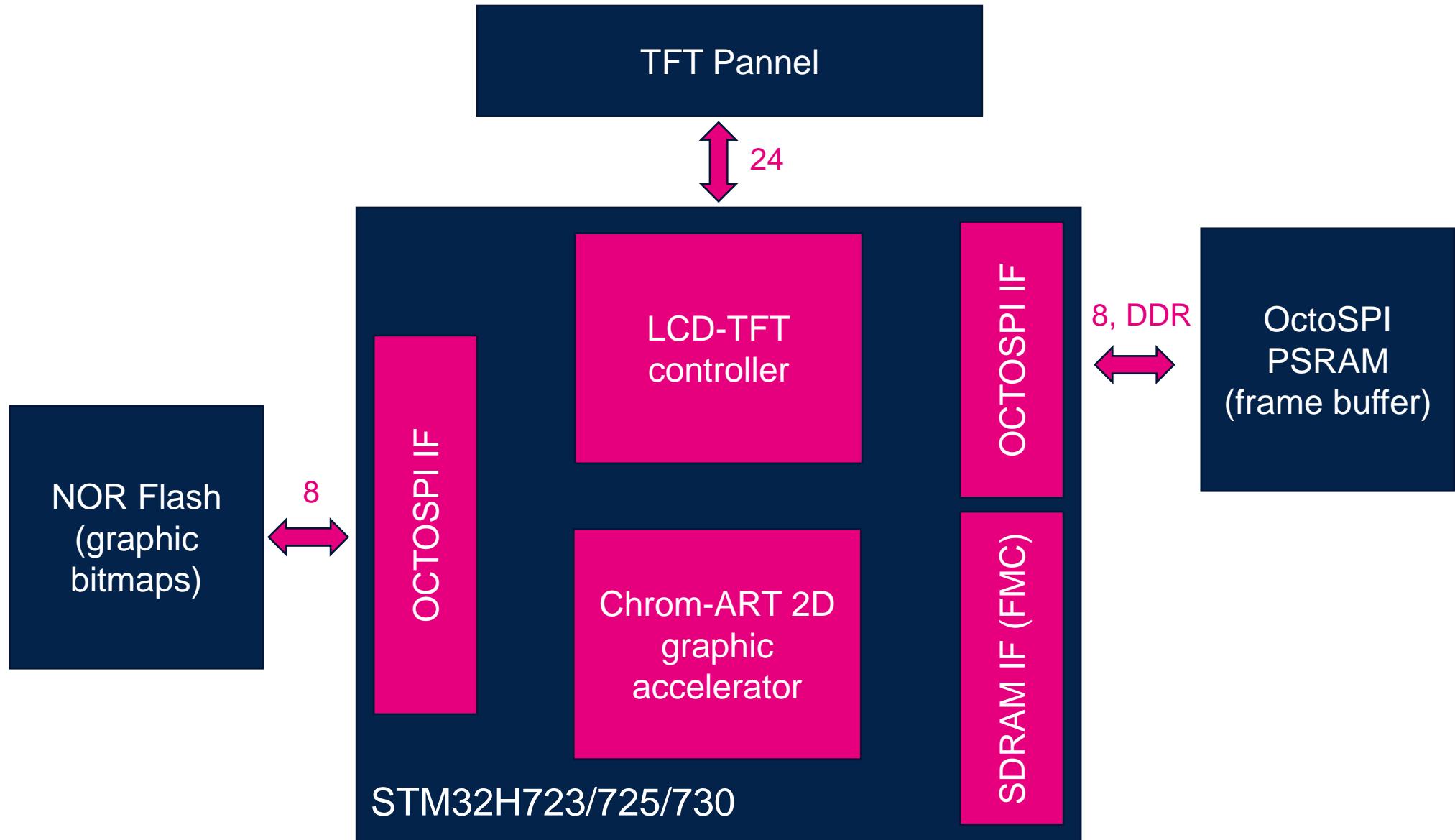
STM32H735RGV3, STM32H735VGT3, STM32H735VGH3, STM32H735ZGT3, STM32H735AGI3, STM32H735IGT3, STM32H735IGK3  
STM32H725RGV3, STM32H725VGT3, STM32H725VGH3, STM32H725ZGT3, STM32H725AGI3, STM32H725IGT3, STM32H725IGK3

# Graphics on STM32H723/H725/H730

## Highest performance with SDRAM



# Graphics on H723/H725/H730 Optimized BOM with OctoSPI PSRAM



# HW Tools : STM32H723 / STM32H735

**STM32 Nucleo : NUCLEO-H723ZG**  
(est. POP 23.2\$, RRP 29\$)



Flexible  
prototyping

Sample Available  
Prod Aug-2020

**Discovery kit : STM32H735G-DK**  
(est. POP 69.6\$, RRP 87\$)



Key feature  
prototyping

Sample Available  
Production : Aug-2020

**Note :** No dedicated tool for the STM32H730 Line. The above Tools should be used instead  
*Value Line*



# Releasing your creativity

► Famous video [here](#)



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